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AF/GP 28264

PATENT

DOCKET NO. 97-C-108
Customer No. 30425

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Tsiu Chiu Chan, et al.
Serial No. : 09/160,824
Filed : September 25, 1998
For : STACKED MULTI-COMPONENT INTEGRATED CIRCUIT
MICROPROCESSOR
Group No. : 2826
Examiner : T. Dickey

BOX AF
Commissioner for Patents
Washington, D.C. 20231

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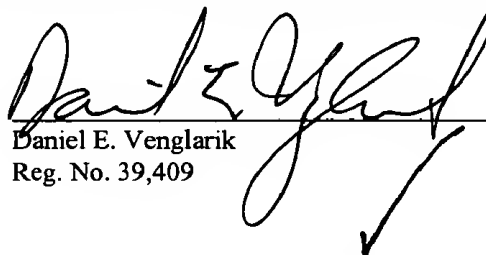
Sir:

The undersigned hereby certifies that the following documents:

1. Notice of Appeal;
2. Petition for Extension of Time - one month (in duplicate);
3. Check in the amount of \$430.00 for the Notice of Appeal filing fee (\$320.00) and one-month extension fee (\$110.00); and
4. A postcard receipt;

relating to the above application, were deposited as "First Class Mail" with the United States Postal Service, addressed to Box AF, Commissioner for Patents, Washington, D.C. 20231, on September 3, 2002.

Date: 9-3-02


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